

Innovative Service Around the Globe

DATA SHEET POSITIVE TEMPERATURE COEFFICIENT AC/DC POWER SUPPLY

PPTC High Temp SMD Series

RoHS compliant



YAGEO | Circuit Protection

POSITIVE TEMPERATURE COEFFICIENT

Positive Temperature Coefficient (PTC) Data Sheet

Compact design saves board space

Compatible with high-volume electronics assembly

Fast response to fault current

Industrial motor driver

Powered outputs

AEC-Q200 qualified

Description

The High Temp SMD series provides surface mount resettable overcurrent protection with holding current from 0.1A to 1.25A. This series offers complete portfolio in terms of holding current and working voltage, and is suitable for wide range of application.

Features

- High Operation Temperature -40°C~125°C
- TUV/UL/RoHS compliant IATF/TS16949 certificated
- Resettable solution against overcurrent and short-circuit

Applications

- Actuators and medium motors
- Industrial power supply
- Automotive ECU and current sensor etc. protection Harness/junction box protection

Part Number	I _{hold}	I _{trip} V _{max}	V _{max}	I _{max} (A)	P _{d typ.} (W)	Maximum Time To Trip		Resistance	
	(A)	(A)	(Vdc)			Time (Sec.)	Current (A)	R _{min} (Ω)	R _{1max} (Ω)
SMDH0805B010TF	0.10	0.60	16	40	1.0	1.5	2.5	0.70	10.0
SMDH1206B010TF	0.10	0.35	30	10	0.8	0.1	1.0	0.70	10.0
SMDH1206B016TF	0.16	0.80	30	20	0.9	0.1	8.0	0.60	6.00
SMDH1206B030TF	0.30	0.82	24	10	1.0	0.1	8.0	0.10	1.95
SMDH1206B035TF	0.35	1.15	16	50	1.0	0.2	3.5	0.15	1.60
SMDH1206B035TF/30	0.35	1.20	30	20	1.2	0.1	8.0	0.10	2.20
SMDH1206B050TF	0.50	2.50	24	20	1.7	0.1	8.0	0.10	1.60
SMDH1206B075TF	0.75	2.00	6	10	1.1	0.1	8.0	0.05	0.40
SMDH1210B010TF	0.10	0.55	30	10	0.9	0.2	1.0	0.50	10.0
SMDH1210B050TF	0.50	1.50	6	10	1.1	0.05	8.0	0.08	0.90
SMDH2920B125TF	1.25	2.50	24	20	2.0	0.5	8.0	0.05	0.29

-www.yageo.com



2

11

High Temp SMD Series

Electrical Characteristics



AGEO Circuit Protection

З

11

Note on Electrical Characteristics

- Vocabulary
- + I_{hold} = Hold current: maximum current device will pass without tripping in 23 $^\circ\!\!\mathbb{C}$ still air.
- + I_{trip} = Trip current: minimum current at which the device will trip in 23 $^\circ\!\mathrm{C}$ still air.
- + V_{max} = Maximum voltage device can withstand without damage at rated current (I_max)
- I_{max} = Maximum fault current device can withstand without damage at rated voltage (V_{max})
- + $P_{d\,typ.}$ = Typical power dissipated from device when in the tripped state at 23 $^\circ\!\mathrm{C}$ still air.
- + R_{min} = Minimum resistance of device in initial (un-soldered) state.
- R_{1max} = Maximum resistance of device at 23 °C measured one hour after tripping or reflow soldering of 260 °C for 20 sec.
- Value specified is determined by using the PWB with 0.030"*1.5oz copper traces.
- Caution: Operation beyond the specified rating may result in damage and possible arcing and flame.
- Specifications are subject to change without notice.

Polymeric PTC Selecting Guide

- Determine the following operating parameters for the circuits:
 - Normal operating current (I_{hold})
 Maximum interrupt current (I_{max})
 - Maximum circuit voltage (V_{max}) Normal operating temperature surrounding device (min°C/max°C)
- Select the device from factor and dimension suitable for the application
- Compare the maximum rating for V_{max} and I_{max} of the PPTC device with the circuit in application and make sure the circuit's requirement does not exceed the device rating.
- Check that PPTC device's trip time (time-to-trip) will protect the circuit.
- Verify that the circuit operating temperature is within the PPTC device's normal operating temperature range.
- Verify that performance and suitability of the chosen PPTC device in the application.

- Mechanical Stress
 - PPTC devices will undergo a thermal expansion during fault condition. If PPTC devices are installed or placed in an application
 where the space between PPTC devices and the surrounding materials (e.g., covering materials, packaging materials, encapsulate
 materials and the like) is insufficient, it will cause an inhibiting effect upon the thermal expansion. Pressing, twisting, bending and
 other kinds of mechanical stress will also adversely affect the performance of the PPTC devices, and shall not be used orapplied.
- Chemical Pollutants
 - Silicone-based oils, oils, solvents, gels, electrolytes, fuels, acids, and the like will adversely affect the properties of PPTC devices, and shall not be used or applied.

Electronic and Thermal Effect

- PPTC devices are secondary protection devices and are used solely for sporadic, accidental over-current or over-temperature error condition, and shall NOT be used if or when constant or repeated fault conditions (such fault conditions may be causedby, among others, incorrect pin-connection of a connector) or over-extensive trip events may occur.
- PPTC devices are different from fuses and, when a fault condition occurs, will go into high-resistance state and do not open circuit, in which case the voltage at such PPTC devices may reach a hazardous level.
- Operation over the maximum rating or other forms of improper use may cause failure, arcing, flame and/or other damage to the PPTC devices.
- Conductive material contamination, such as metal particle, may induce shortage, flame or arcing.
- Due to the inductance, the operation circuits may generate a circuit voltage (Ldi/dt) above the rated voltage of PPTC devices, which shall not be used under such circumstances.

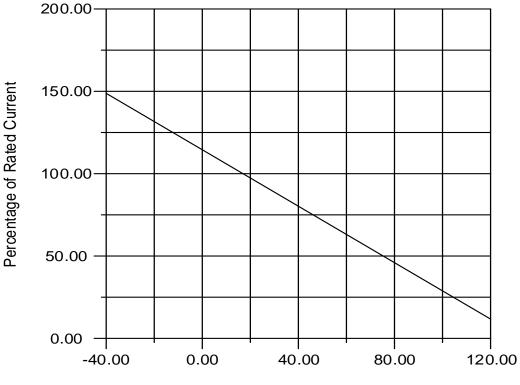
YAGEO , Circuit Protection

POSITIVE TEMPERATURE COEFFICIENT High Temp SMD Series 4

General

- · Customers shall evaluate and test the properties of PPTC devices independently to verify and ensure that their individual applications will be met.
- The performance of PPTC devices will be adversely affected if they are improperly used under electronic, thermal and/or mechanical procedures and/or conditions non-conformant to those recommended by manufacturer.
- Customers shall be responsible for determining whether it is necessary to have back-up, failsafe and/or fool-proof protection To avoid or minimize damage that may result from extra-ordinary, irregular function or failure of PPTC devices.
- Any and all responsibilities and liabilities are disclaimed if any item under this notice of warning is not complied with.

Thermal Derating Curve



Device Ambient Temperature (°C)

POSITIVE TEMPERATURE COEFFICIENT High Temp SMD Series

Thermal Derating Chart

Ambient Operation Temperature Part Number **-40°**℃ **-20°**℃ 0°C **25℃ 40°**C **50**℃ **60°**C **70°**℃ **85°**℃ SMDH0805B010TF 0.15 0.13 0.115 0.100 0.09 0.084 0.078 0.072 0.063 SMDH1206B010TF 0.18 0.15 0.10 0.09 0.08 0.07 0.07 0.06 0.16 SMDH1206B016TF 0.25 0.21 0.19 0.16 0.14 0.13 0.12 0.11 0.09 SMDH1206B030TF 0.45 0.40 0.35 0.30 0.25 0.22 0.20 0.18 0.13 SMDH1206B035TF 0.54 0.48 0.43 0.35 0.32 0.29 0.26 0.24 0.20 SMDH1206B035TF/30 0.51 0.46 0.41 0.35 0.31 0.29 0.26 0.24 0.20 SMDH1206B050TF 0.73 0.58 0.50 0.45 0.42 0.39 0.35 0.31 0.66 SMDH1206B075TF 1.07 0.98 0.90 0.75 0.70 0.66 0.61 0.56 0.50

0.15

0.75

1.50

0.10

0.50

1.25

0.09

0.48

1.15

0.08

0.45

1.08

Recommended Hold Current (A) at Ambient Temperature (°C)

Average Time-Current Curve

0.18

0.85

1.80

0.16

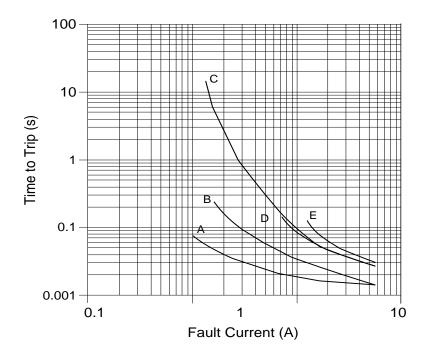
0.78

1.65

SMDH1210B010TF

SMDH1210B050TF

SMDH2920B125TF



A-SMDH0805B010TF B-SMDH1206B016TF C-SMDH1206B035TF D-SMDH1206B035TF/30 E-SMDH1206B050TF

0.07

0.42

1.00

0.06

0.38

0.90

0.05

0.35

0.80



 $\frac{5}{11}$

125℃

0.04

0.03

0.05

0.05

0.10

0.10

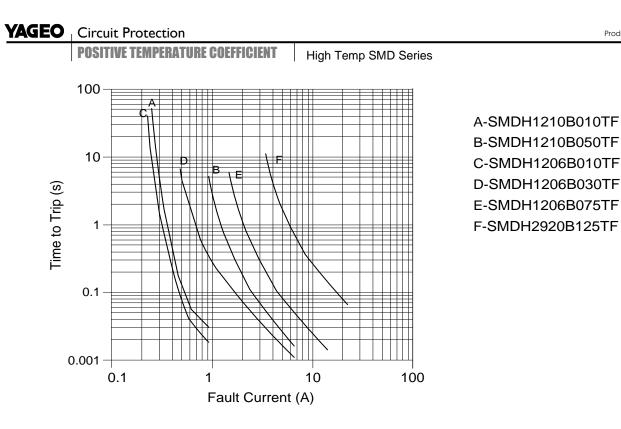
0.17

0.30

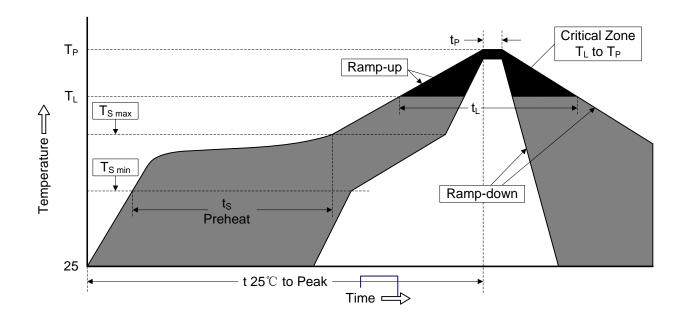
0.02

0.18

0.28



Soldering Parameters



11

YAGEO | Circuit Protection

POSITIVE TEMPERATURE COEFFICIENT

7

11

Profile Feature	Pb-Free Assembly
Average ramp-up rate ($T_{S max}$ to T_P)	3℃ /second max.
Preheat -Temperature Min (T _{S min}) -Temperature Max (T _{S max}) -Time (min to max) (T _{S min} to T _{S max})	150℃ 200℃ 60-180 seconds
Time maintained above: -Temperature (T_L) -Time (t_L)	217℃ 60-150 seconds
Peak Temperature (T _P)	260 ℃
Time within 5 $^\circ\!{\mathbb C}$ of actual Peak Temperature (t_P)	20-40 seconds
Ramp-down Rate	6℃ /second max.
Time 25°C to Peak Temperature	8 minutes max.
Storage Condition	0°C~35°C , ≤70%RH

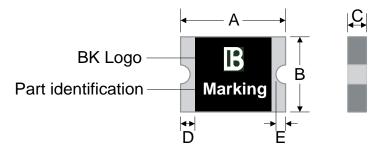
• Recommended reflow methods: IR, vapor phase oven, hot air oven, N2 environment for lead-free

- Recommended maximum paste thickness is 0.25mm (0.010 inch)
- Device can be cleaned using standard industry methods and solvents.

Note 1: All temperature refer to topside of the package, measured on the package body surface.

Note 2: If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.

Physical Dimensions (mm)



Part	ŀ	Ą	В		С		D		E	
Number	Min.	Max.								
SMDH0805B010TF	2.00	2.20	1.20	1.50	0.50	0.80	0.25	0.75	0.05	0.45
SMDH1206B010TF	3.00	3.40	1.50	1.80	0.30	0.70	0.25	0.75	0.05	0.45
SMDH1206B016TF	3.00	3.40	1.50	1.80	0.50	0.80	0.25	0.75	0.05	0.45
SMDH1206B030TF	3.00	3.40	1.50	1.80	0.40	0.80	0.25	0.75	0.05	0.45
SMDH1206B035TF	3.00	3.40	1.50	1.80	0.40	0.80	0.25	0.75	0.05	0.45
SMDH1206B035TF/30	3.00	3.40	1.50	1.80	0.80	1.30	0.25	0.75	0.05	0.45

YAGEO Circuit Protection

POSITIVE TEMPERATURE COEFFICIENT High Temp SMD Series

Part	ŀ	Ą	В		С		D		E	
Number	Min.	Max.								
SMDH1206B050TF	3.00	3.40	1.50	1.80	0.60	1.00	0.25	0.75	0.05	0.45
SMDH1206B075TF	3.00	3.40	1.50	1.80	0.60	1.00	0.25	0.75	0.05	0.45
SMDH1210B010TF	3.00	3.43	2.35	2.80	0.50	0.98	0.25	0.75	0.10	0.50
SMDH1210B050TF	3.00	3.43	2.35	2.80	0.25	0.65	0.25	0.75	0.10	0.50
SMDH2920B125TF	6.73	7.98	4.80	5.44	0.50	1.00	0.30	2.50	0.25	1.50

Environmental Specifications

Operating / Storage temperature	-40℃ to +125℃
Maximum Device Surface Temperature in Tripped State	175℃
	+125℃, 1000 hours
Passive Aging	
	±50% typical resistance change
	+85℃, 85%R.H. 1000 hours
Humidity Aging	
	±50% typical resistance change
	MIL-STD-202, Method 107G
Thermal Shock	+125℃/-40℃ 20 times
	-50% typical resistance change
	MIL-STD-202, Method 215
Solvent Resistance	No change
	MIL-STD-883C, Method 2007.1, Condition A
Vibration	No change
Moisture Level Sensitivity	Level 1, J-STD-020C

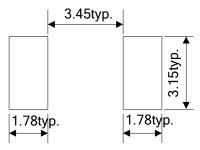
POSITIVE TEMPERATURE COEFFICIENT

High Temp SMD Series

<u>9</u> 11

Packaging Quantity and Marking

Recommended Pad Layout (mm)



Part Number	Marking	Quantity
SMDH0805B010TF	С	4000
SMDH1206B010TF	10	4000
SMDH1206B016TF	16	4000
SMDH1206B030TF	H3	4000
SMDH1206B035TF	35	4000
SMDH1206B035TF/30	V	4000
SMDH1206B050TF	50	4000
SMDH1206B075TF	H7	4000
SMDH1210B010TF	01	4000
SMDH1210B050TF	H5	4000
SMDH2920B125TF	H12	2000

◎ 12mm tape on 7 inch reel per EIA-481 (equivalent to IEC286, part 3)

Physical Specifications

Terminal Material	Solder-Plated Copper (Solder Material: Matte Tin (Sn))					
Plating Thickness	Sn: ≥15µm ,Cu: ≥20 µ m					
Lead Solderability	Meets EIA Specification RS186-9E, ANSI/J-STD-002 Category 3.					

YAGEO | Circuit Protection

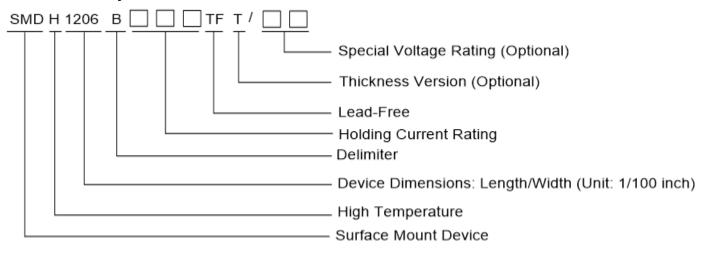
POSITIVE TEMPERATURE COEFFICIENT

High Temp SMD Series

Packaging

Таре		Dimensions (mm)							
	Symbol	H0805B010TF	H1206B010TF H1206B016TF H1206B030TF H1206B035TF	H1206B035TF/30 H1206B050TF H1206B075TF	H1210B010TF H1210B050TF	H2920B125TF			
	W	8.00±0.30	8.00±0.30	8.00±0.30	8.00±0.30	16.00±0.30			
, P0 , P2 , P1 , D0 , T	F	3.50±0.05	3.50±0.05	3.50±0.05	3.50±0.05	7.50±0.10			
	E	1.75±0.10	1.75±0.10	1.75±0.10	1.75±0.10	1.75±0.10			
	D0	1.55±0.05	1.55±0.05	1.55±0.05	1.55±0.05	1.55±0.05			
	D1	1.00(MIN)	1.00±0.10	1.00±0.10	1.00(MIN)	1.50±0.10			
K0	P0	4.00±0.10	4.00±0.10	4.00±0.10	4.00±0.10	4.00±0.10			
	P1	4.00±0.10	4.00±0.10	4.00±0.10	4.00±0.10	8.00±0.10			
	P2	2.00±0.05	2.00±0.05	2.00±0.05	2.00±0.05	2.00±0.10			
	A0	1.60±0.10	1.95±0.10	1.92±0.10	2.82±0.10	5.74±0.10			
	B0	2.30±0.10	3.65±0.10	3.65±0.10	3.46±0.10	8.02±0.10			
	Т	0.25±0.10	0.20±0.10	0.20±0.10	0.25±0.10	0.30±0.05			
	K0	0.90±0.10	0.87±0.10	1.30±0.10	1.00±0.10	0.91±0.10			
	Leader min.	390	390	390	390	390			
	Trailer min.	160	160	160	160	160			
Reel	С	Ф178.0±1.0	Ф178.0±1.0	Ф178.0±1.0	Ф178.0±1.0	Ф180.0±3.0			
	D	Ф60.2±0.5	Ф60.2±0.5	Ф60.2±0.5	Ф60.2±0.5	Ф60.0±0.5			
C C C C C C C C C C C C C C C C C C C	Н	11.0±0.5	11.0±0.5	11.0±0.5	11.0±0.5	19.5±1.0			
	W	9.0±1.5	9.0±1.5	9.0±1.5	9.0±1.5	17.0±0.2			

Part Number System



LEGAL DISCLAIMER

YAGEO, its distributors and agents (collectively, "YAGEO"), hereby disclaims any and all liabilities for any errors, inaccuracies or incompleteness contained in any product related information, including but not limited to product specifications, datasheets, pictures and/or graphics. YAGEO may make changes, modifications and/or improvements to product related information at any time and without notice.

YAGEO makes no representation, warranty, and/or guarantee about the fitness of its products for any particular purpose or the continuing production of any of its products. To the maximum extent permitted by law, YAGEO disclaims (i) any and all liability arising out of the application or use of any YAGEO product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for a particular purpose, non -infringement and merchantability.

YAGEO products are designed for general purpose applications under normal operation and usage conditions. Please contact YAGEO for the applications listed below which require especially high reliability for the prevention of defects which might directly cause damage to the third party's life, body or property: Aerospace equipment (artificial satellite, rocket, etc.), Atomic energy-related equipment, Aviation equipment, Disaster prevention equipment, crime prevention equipment, Electric heating apparatus, burning equipment, Highly public information network equipment, data-processing equipment, Medical devices, Military equipment, Power generation control equipment, Safety equipment, Traffic signal equipment, Transportation equipment and Undersea equipment, or for any other application or use in which the failure of YAGEO products could result in personal injury or death, or serious property damage. Particularly **YAGEO Corporation and its affiliates do not recommend the use of commercial or automotive grade products for high reliability applications or manned space flight.**

Information provided here is intended to indicate product specifications only. YAGEO reserves all the rights for revising this content without further notification, as long as products are unchanged. Any product change will be announced by PCN.